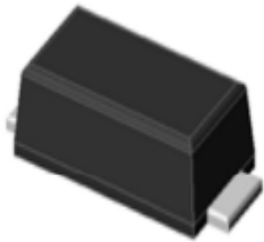


Surface Mount Glass Passivated Standard Rectifier
SOD-123FL(eSGA)

Features

- ROHS compliant
- Glass passivated chip
- High forward surge capability
- Meet MSL level 1, per J-STD-020 LF maximum peak of 250 °C
- Solder dip 260 °C / 40S
- Component in accordance to ROHS 2002/95/EC and WEEE 2002/96/WC
- UL recognition, file number E342874


Primary characteristics

$I_{F(AV)}$	1.5A
V_{RRM}	1000V
I_{FSM}	52A
I_{RM}	5 μ A
V_{FM} at $I_F=1.5A$	1.1V
T_J max.	150 °C

Applications

Ideal for ac-to-dc bridge full wave rectification such as SMPS, home appliances, office equipment, industrial automation applications

Mechanical data

- SOD-123FL(eSGA)
- Epoxy meets UL 94 V-0 flammability rating
- Terminals: Tin plated leads.
- Polarity: As marked.
- Mounting Torque:10cm·kg(8.8 inches·lbs)max.
- Recommended Torque:5.7 cm·kg(5 inches·lbs)

Maximum rating (Ta=25°C unless otherwise noted)

Parameter	Sym	SOD-123FL(eSGA)		Unit
		F1510A		
Max. repetitive peak reverse voltage	V_{RRM}	1000		V
Max. RMS reverse voltage	V_{RMS}	700		V
Max. DC blocking voltage	V_{DC}	1000		V
Max. average forward current	$I_{F(AV)}$	1.5		A
Non-repetitive peak forward surge current 8.3ms single half-sine-wave	I_{FSM}	52		A
Max. instantaneous forward voltage drop per diode	V_{FM}	1.1 (1.5A)		V
Max. instantaneous reverse current at rated DC blocking voltage	I_{RM}	Ta=25 °C	5	μ A
		Ta=125 °C	50	μ A
Operating junction temperature	T_J	-55 ~ +150		°C
Storage temperature	T_{STG}	-55 ~ +150		°C
Typical thermal resistance (Note 1)	R J-A	70		°C/W
	R J-C	35		°C/W
	R J-M	14		°C/W
Typical junction capacitance (Note 2)	C_J	6		pF
Typical reverse recovery time (Note 3)	t_{rr}	1.8		us

- Notes:** 1. The thermal resistance from junction to ambient, case or mount, mounted on P.C.B with 5x5mm copper pads, 2 OZ, FR4 PCB
 2. Measured at 1 MHz and Applied Reverse Voltage of 4.0 V D.C
 3. Reverse recovery test conditions: $I_F=0.5A$, $I_R=1.0A$, $I_{rr}=0.25A$



Ordering information (Example)

PREFERRED	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
F1510A				

Typical characteristics

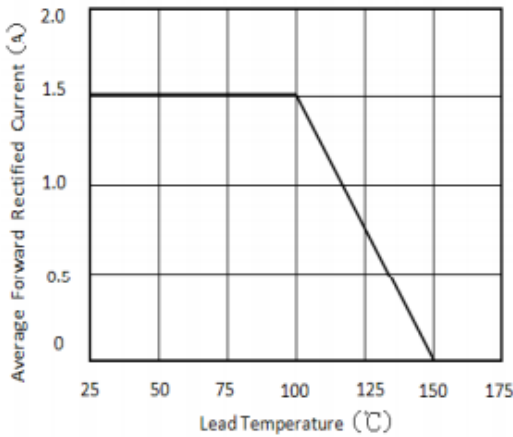


Figure 1. Forward Current Derating Curve

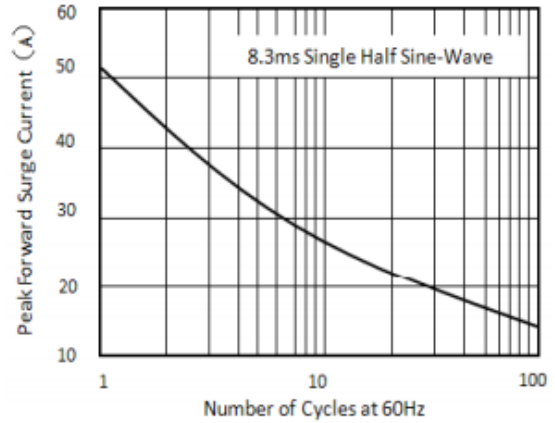


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

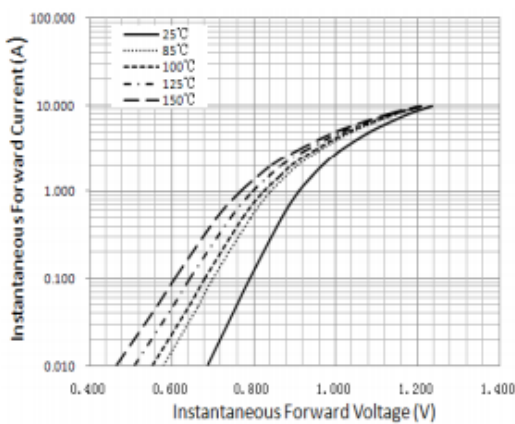


Figure 3. Typical Instantaneous Forward Characteristics

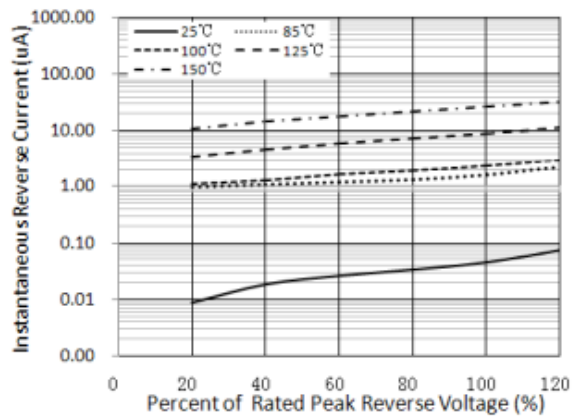
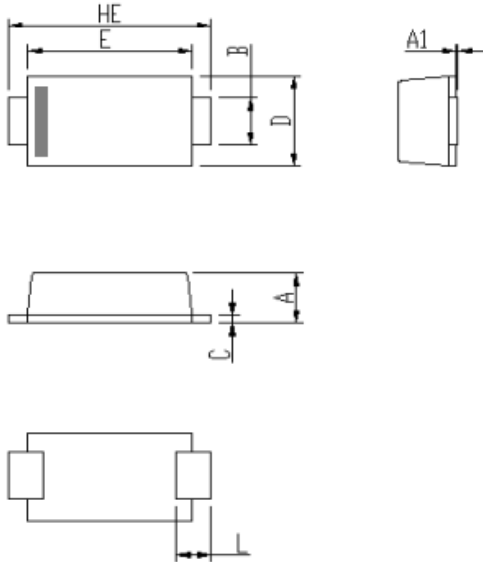


Figure 4. Typical Reverse Characteristics

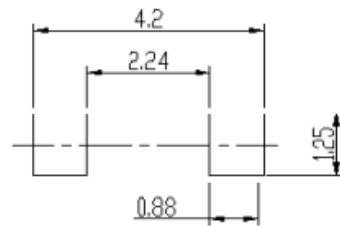
Package outline dimensions

in inches (millimeters)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.9	1.08	0.035	0.043
A1	0	0.1	0.000	0.004
B	0.85	1.05	0.033	0.041
C	0.1	0.25	0.004	0.010
D	1.7	2	0.067	0.079
E	2.9	3.1	0.114	0.122
L	0.43	0.83	0.017	0.033
HE	3.5	3.9	0.138	0.154

Soldering footprint



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